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Information Materials

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Message from the Guest Editors

Dear Colleagues,

Information materials, a group of functional materials used for the purposes of detection, transmission, storage, and display, are the cornerstone of the modern information society. In particular, emerging new materials and novel device structures have been considered for next-generation information technology.

This Special Issue will mainly address comprehensive reviews and original research articles featuring important and recent developments in information detection materials and devices. Materials and sensors with functions such as photosensitive, piezoelectric, and electromagnetic functions are encouraged. This Special Issue will also serve as a platform for researchers working in information materials to communicate their findings and visionary reviews as well as bring the materials science and information technology together to contribute to this emerging field. In particular, serving as a high-quality platform for scientists working in a wide variety of research areas including information technology, energy materials, materials sciences and engineering, applied physics and chemistry, and so on, to communicate their findings and opinions.



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Special Issue



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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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